# SQS660CENW

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**Vishay Siliconix** 

# Automotive N-Channel 60 V (D-S) 175 °C MOSFET



Marking code: Q051

PRODUCT SUMMARY	
V <sub>DS</sub> (V)	60
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0112
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS}$ = 4.5 V	0.0160
I <sub>D</sub> (A)	18
Configuration	Single

#### **FEATURES**

- TrenchFET<sup>®</sup> power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

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COMPLIANT HALOGEN FREE

N-Channel MOSFET

#### ORDERING INFORMATION

Package	PowerPAK 1212-8W
Lead (Pb)-free and halogen-free	SQS660CENW (for detailed order number please see <u>www.vishay.com/doc?79776</u> )

<b>ABSOLUTE MAXIMUM RATINGS</b>	(T <sub>C</sub> = 25 °C, unless	s otherwise notec	)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	60	v
Gate-source voltage		V <sub>GS</sub>	± 20	v
Continuous drain current <sup>a</sup>	T <sub>C</sub> = 25 °C	I	18	
Continuous drain current "	T <sub>C</sub> = 125 °C	I <sub>D</sub>	18	
Continuous source current (diode conduction)	I <sub>S</sub>	18	A	
Pulsed drain current <sup>b</sup>		I <sub>DM</sub>	72	
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	24.5	
Single pulse avalanche energy	L = 0.1 IIIH	E <sub>AS</sub>	30	mJ
Maximum power dissinction	T <sub>C</sub> = 25 °C	D	62.5	W
Maximum power dissipation	T <sub>C</sub> = 125 °C	P <sub>D</sub>	20	vv
Operating junction and storage temperature range Soldering recommendations (peak temperature) <sup>d, e</sup>		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C
			260	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount <sup>c</sup>	R <sub>thJA</sub>	81	°C/W	
Junction-to-case (drain)		R <sub>thJC</sub>	2.4	0/11	

#### Notes

a. Package limited

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

c. When mounted on 1" square PCB (FR4 material)

d. See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8W is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

S20-0925-Rev. A, 30-Nov-2020

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PARAMETER

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**SPECIFICATIONS** (T<sub>C</sub> = 25 °C, unless otherwise noted)

SYMBOL

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ed)				
TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{GS} = 0, I_D = 250 \ \mu A$	60	-	-	V
$V_{-2} = V_{-2} = 1_{-2} = 250 \mu \Lambda$	15	20	25	v

Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0, I <sub>D</sub> = 250 μA	60	-	-	V	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$		1.5	2.0	2.5	v	
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V	-	-	1		
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	μA	
		$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	150		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	15	-	-	А	
		$V_{GS} = 10 V$	I <sub>D</sub> = 7 A	-	0.0091	0.0112		
	D	$V_{GS} = 10 V$	I <sub>D</sub> = 7 A, T <sub>J</sub> = 125 °C	-	-	0.0175	0	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 7 A, T <sub>J</sub> = 175 °C	-	-	0.0207	Ω	
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 5 A	-	0.0129	0.0160		
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 7 A	-	26	-	S	
Dynamic <sup>b</sup>								
Input capacitance	C <sub>iss</sub>			-	1363	1950		
Output capacitance	Coss	$V_{GS} = 0 V$	$V_{GS} = 0 V$ $V_{DS} = 25 V, f = 1 MHz$	-	565	800	μA Α Ω	pF
Reverse transfer capacitance	C <sub>rss</sub>			-	22	31		
Total gate charge <sup>c</sup>	Qg			-	17.4	26		
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 4 \text{ A}$	-	4.8	-	nC	
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>			-	1.1	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz		0.27	0.54	0.81	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>			-	12	20		
Rise time <sup>c</sup>	tr	V <sub>DD</sub> =	$=$ 30 V, R <sub>L</sub> = 7.5 $\Omega$	-	4	10		
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	I <sub>D</sub> ≅ 4 Å, \	$V_{\text{GEN}} = 10$ V, $R_{\text{g}} = 1 \Omega$	-	20	35	ns	
Fall time <sup>c</sup>	t <sub>f</sub>			-	5	10		
Source-Drain Diode Ratings and Charact	eristic <sup>b</sup>	•		•	•			
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	72	А	
Forward voltage	$V_{SD}$	I <sub>F</sub> =	= 7 A, V <sub>GS</sub> = 0 V	-	0.8	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>			-	27	55	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	1		-	21	45	nC	
Reverse recovery fall time	t <sub>a</sub>	I <sub>F</sub> = 5 /	A, di/dt = 100 A/μs	-	14	-		
Reverse recovery rise time	t <sub>b</sub>	1		-	13	-	ns	
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-1.4	-	А	

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

b. Guaranteed by design, not subject to production testing

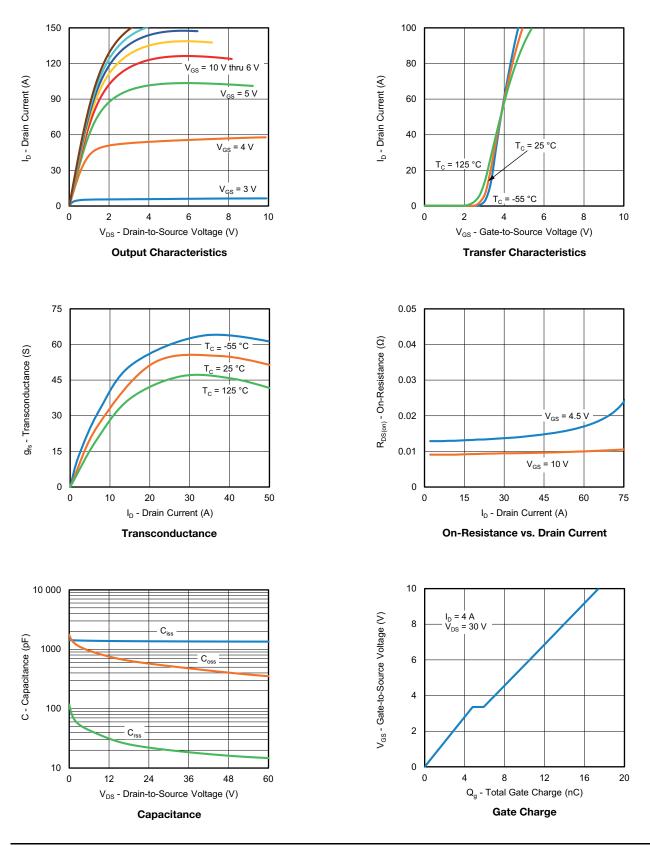
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



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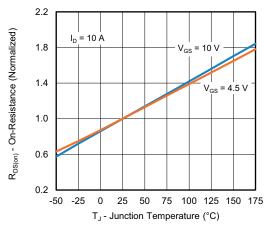
3

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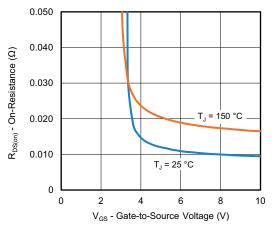
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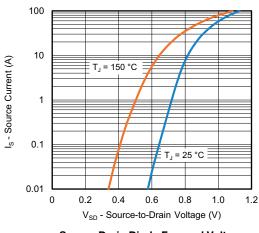
## TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



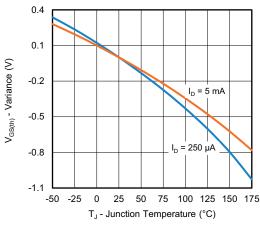
**On-Resistance vs. Junction Temperature** 



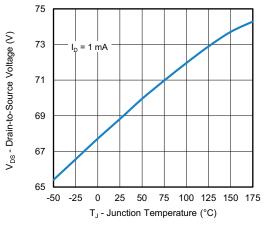
**On-Resistance vs. Gate-to-Source Voltage** 



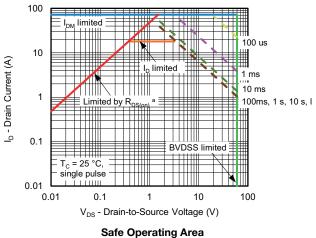
Source Drain Diode Forward Voltage



**Threshold Voltage** 



Drain Source Breakdown vs. Junction Temperature



a. V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

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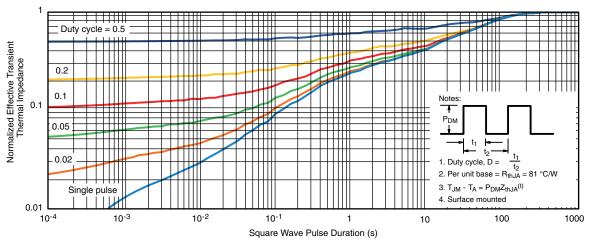
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Note

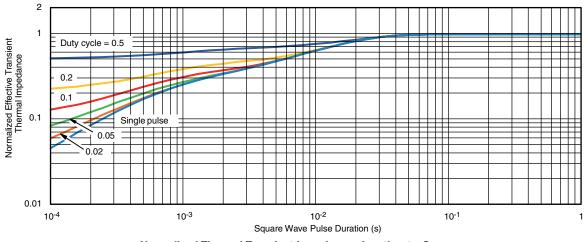




#### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

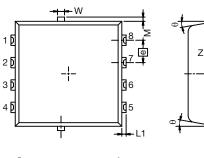
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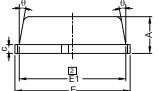


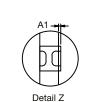
# PowerPAK<sup>®</sup> 1212-8W Case Outline

Δ2

224



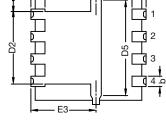




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E2

E4

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Notes
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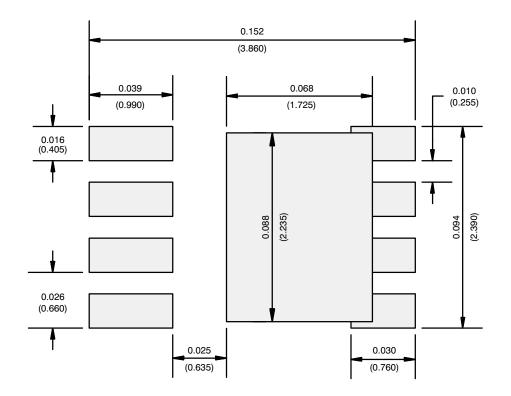
 Dimensions exclusive of mold gate burrs
 Dimensions exclusive of mold flash and cutting burrs

DIM.	MILLIMETERS			INCHES			
DIN.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.97	1.04	1.12	0.038	0.041	0.044	
A1	0	-	0.05	0	-	0.002	
A2	0	-	0.13	0	-	0.005	
b	0.23	0.30	0.41	0.009	0.012	0.016	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.95	3.05	3.15	0.116	0.120	0.124	
D2	1.98	2.11	2.24	0.078	0.083	0.088	
D4		0.47 typ.			0.0185 typ.		
D5		2.3 typ.			0.090 typ.		
E	3.20	3.30	3.40	0.126	0.130	0.134	
E1	2.95	3.05	3.15	0.116	0.120	0.124	
E2	1.47	1.60	1.73	0.058	0.063	0.068	
E3	1.75	1.85	1.98	0.069	0.073	0.078	
E4		0.34 typ.			0.013 typ.		
е		0.65 BSC.			0.026 BSC	0.026 BSC	
К	0.86 typ.				0.034 typ.		
Н	0.30	0.41	0.51	0.012	0.016	0.020	
L	0.30	0.43	0.56	0.012	0.017	0.022	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М		0.125 typ.		0.005 typ.			
N: C15-1530-R /G: 6032	Rev. B, 16-Nov-15						

Backside view of single pad



## **RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single**



Recommended Minimum Pads Dimensions in Inches/(mm)

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